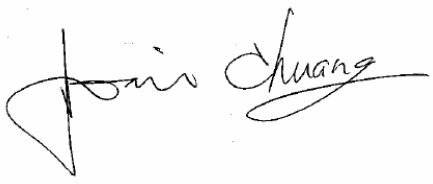
Harvatek Surface Mount CHIP LEDs Approval Sheet
Model No.: HT-191YG5

Acknowledged by



Section Manager	**Manager**
Production Engineering Dept.	**Production Engineering Dept.**

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LIFE SUPPORT POLICY

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Product Specification

	Specification	Material	Quantity
Iv	J: 4.5-7.15mcd K: 7.15-11.25mcd L: 11.25-18 mcd @5mA/ Ta= 25^{O} C Tolerance: ± 10%		
lambda(λ_D)	570-577nm @5mA/ Ta= 25^{O} C Tolerance: ± 0.5nm		
Vf	1.6-2.4 V @5mA/ Ta= 25^{O} C Tolerance: ± 0.05V		
Ir	< 100 μA @ V_R = 5 V		
Resin	Milky White	Epoxy resin	
Carrier tape	According to EIA 481-1A specs	Transparent	4000pcs per reel
Reel	According to EIA 481-1A specs	Plastic/ White	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified

Others:

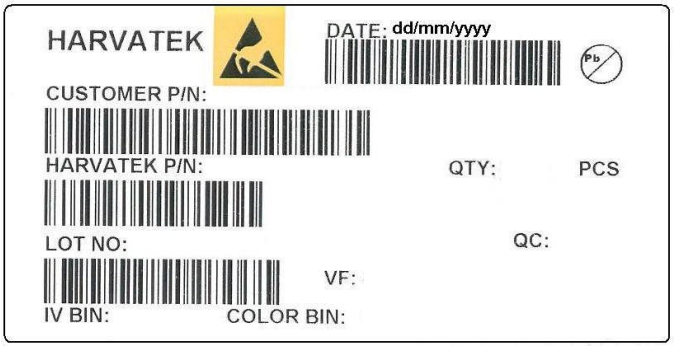
Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

ATTENTION: Electrostatic Discharge (ESD) protection

The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Label Spec.:



■**Customer P/N: HT-191YG5-A168**

■ **Harvatek P/N**

H T - 1 9 1 YG5

Series Name	Emitting Color
HT-191: 1.6x0.8x0.6mm	YG5: Yellow Green

■ **Lot No.**

1	2	3	4	5	6	7	8	9	10
P	**1**	**2**	**2**	**3**	**0**	**A**	**-**	**D**	**T**

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
Internal Tracing Code	Z: 2000 1: 2001 2: 2002 3: 2003 …..	1: Jan. 2: Feb. …. 9: Sep. A: Oct. B: Nov. C: Dec.	1~31/ (30)	01~99, A,B,C…	D: Milky White	T: Taped Reel

■Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range
Yellow Green	J	4.5-7.15mcd
	K	7.15-11.25mcd
	L	11.25-18 mcd

■ Dominant Wavelength (λ_D) Bin:

Color	Bin Code	Spec. Range
Yellow Green	D	570-573.5 nm
	E	573.5-577 nm

■ Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
Yellow Green	-	1.6-2.4V

Product Feature

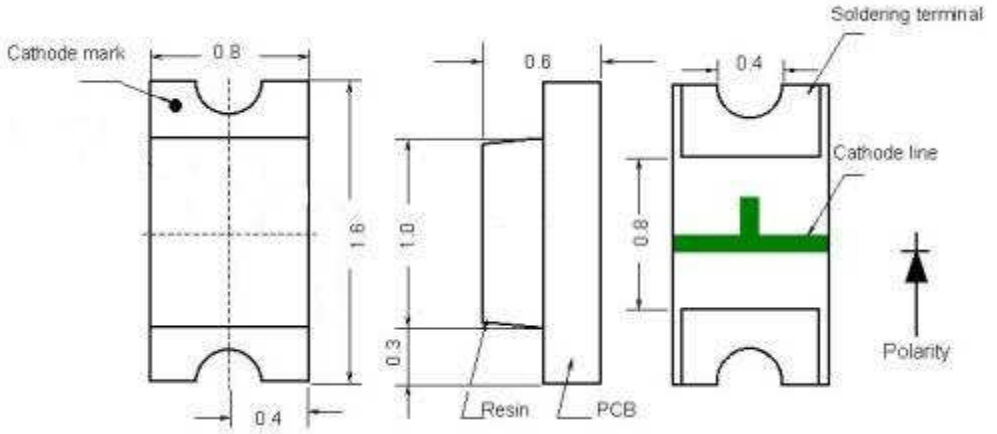
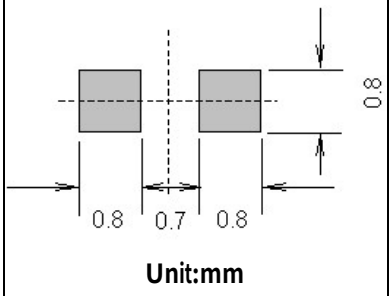
Electro-Optical Characteristics

(I_F @ 5mA, T_a 25°C)

Code for parts	Lighting Color	Material	V_F(V)		λ(nm)			I^*_V(mcd)
			typ	max	λ_p	λ_d	△λ	Typ
HT-191YG5	Yellow Green	GaP	2.2	2.6	573	568	30	7.15

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1

Outline Dim.	Soldering Pattern
	

Soldering terminal may shift in x, y direction.

Absolute Maximum Ratings

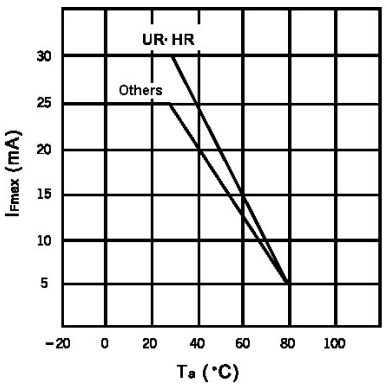
(T_a 25°C)

Series	P_d (mW)	I_F (mA)	I_{FP} (mA)	V_R (V)	T_{OP} (°C)	T_{ST} (°C)
HT-191YG	65	25	100**	5	-30~+80	-40~+85

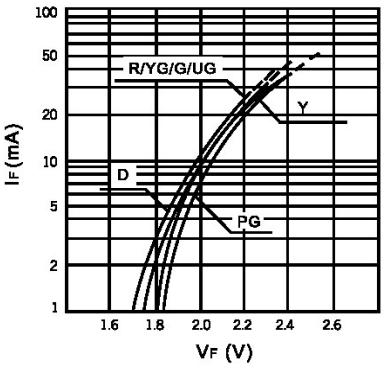
** Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

Characteristics of HT-191 Series

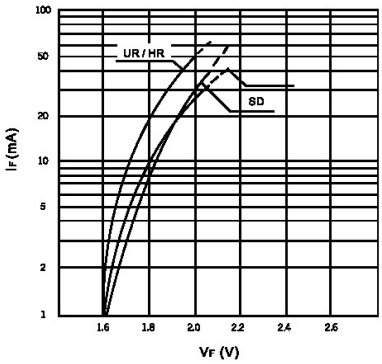
IFmax-Ta Characteristics



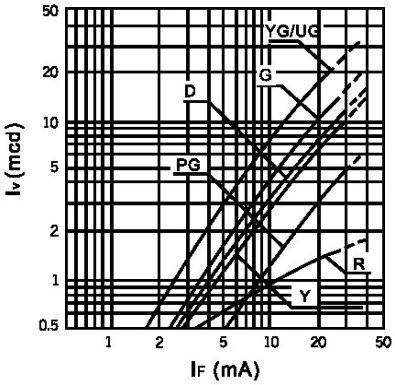
IF-VF Characteristics



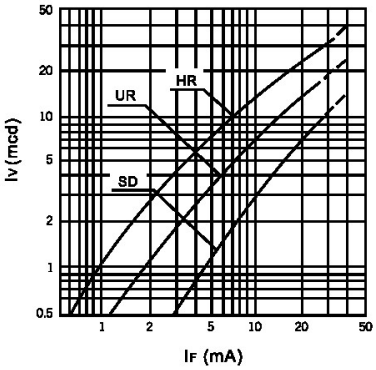
IF- VF Characteristics



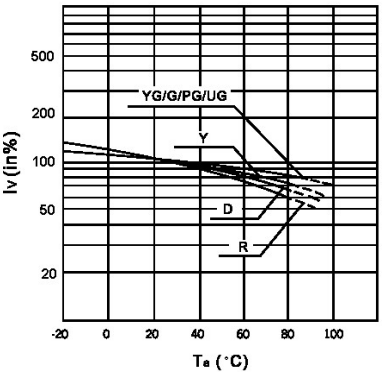
Iv-IF Characteristics



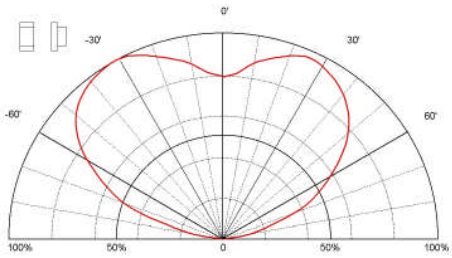
Iv-IF Characteristics



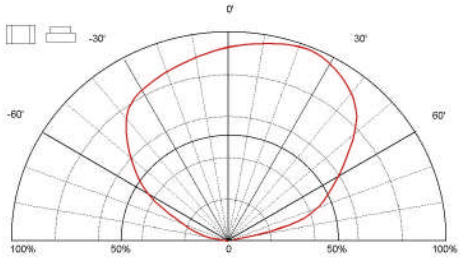
Iv-Ta Characteristics



Directive Characteristics

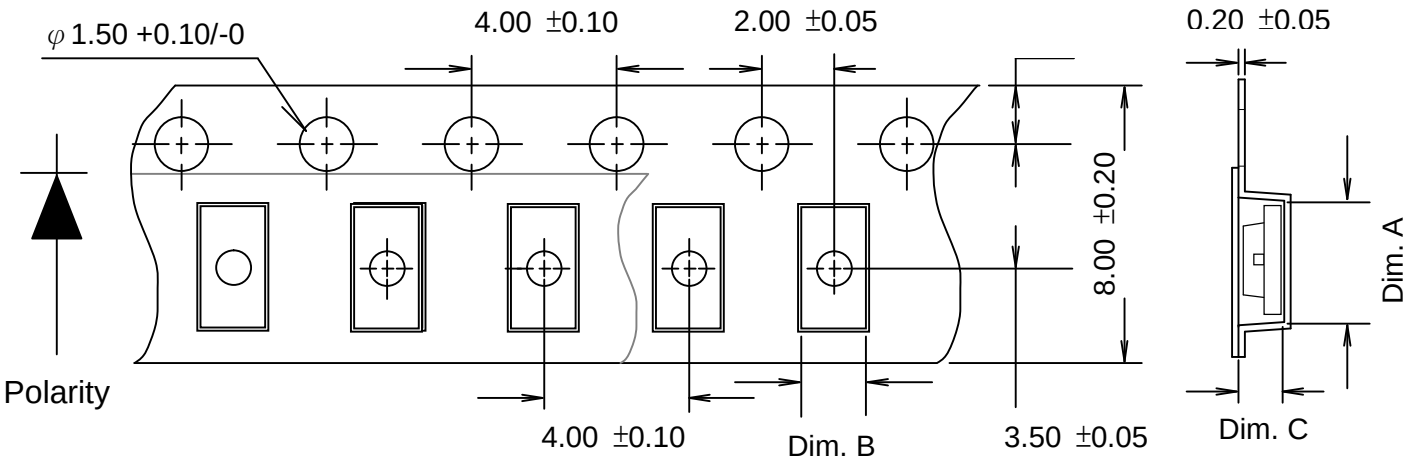


Directive Characteristics



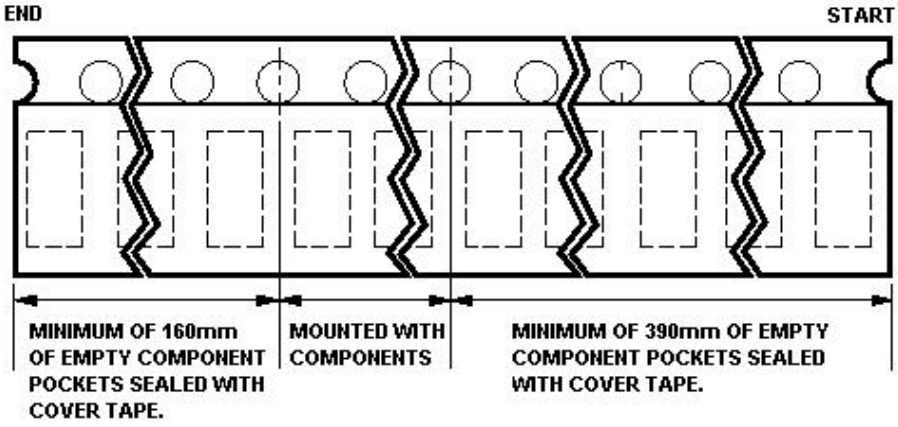
Packaging Tape, Reel, and Packing Model

Tape Dimension

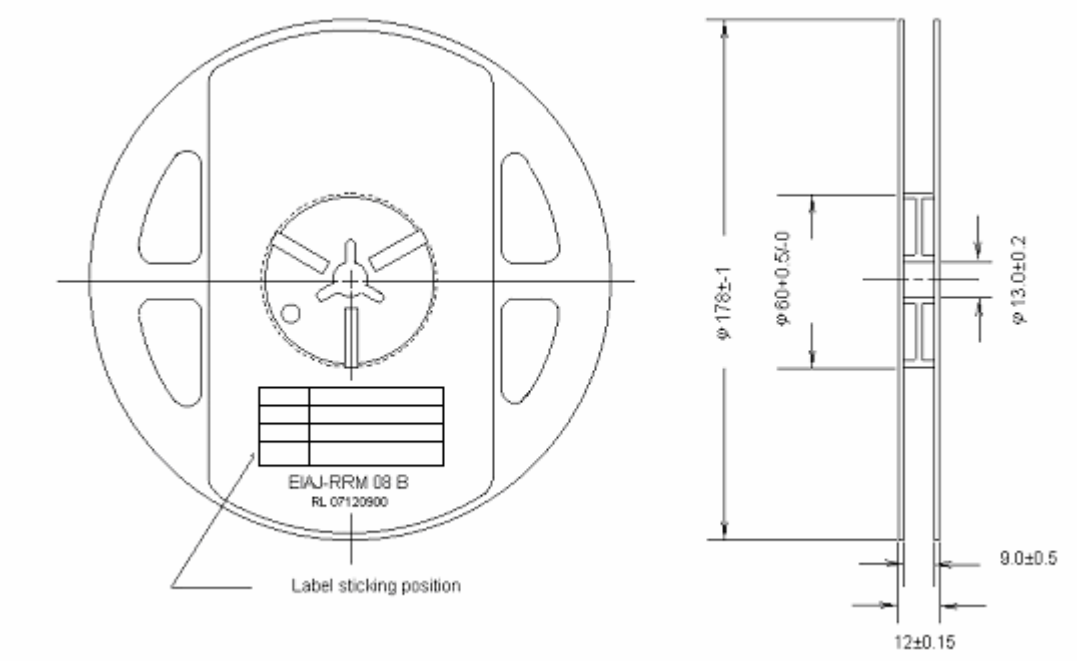


Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-191	1.80±0.10	0.95±0.10	0.75±0.10	4K

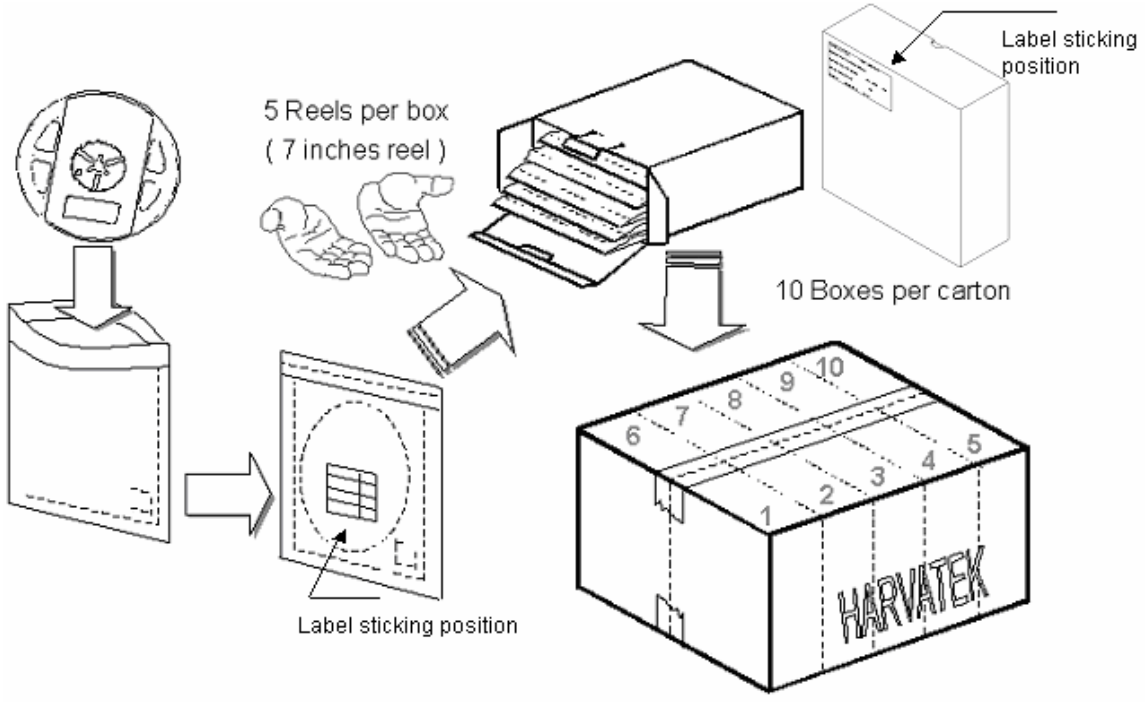
Unit: mm



Reel Dimension



Packing



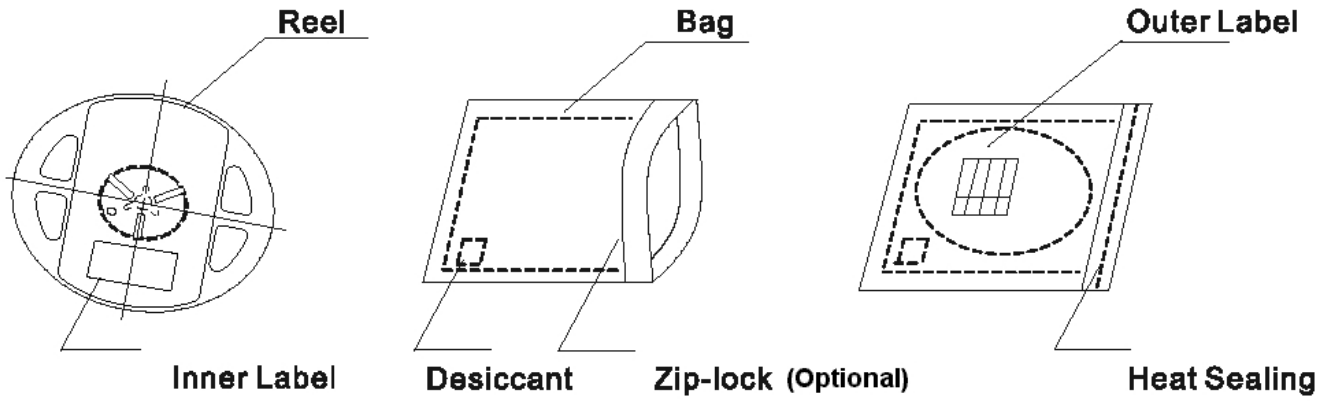
5 boxes per carton is available depending on shipment quantity.

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



PRECAUTIONS

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

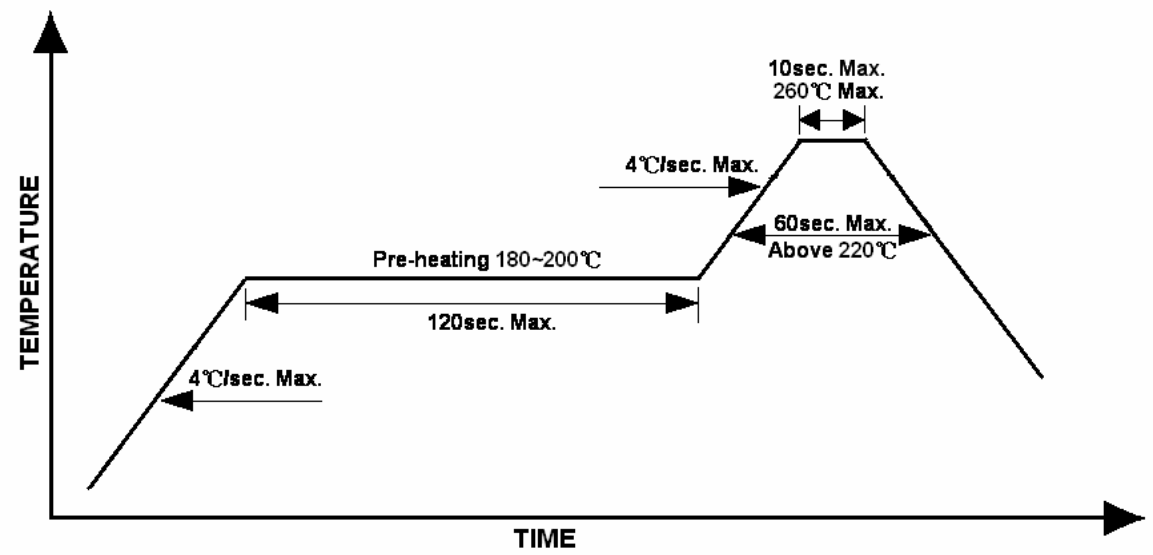
Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 220 ^{O}C ,60 sec.
2. Peak temp.:260 ^{O}CMax.,10sec Max.

3. Never attempt next process until the component is cooled down to room temperature after reflow.
4. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 ^{O}C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50^{o}C x 30sec. or <30^{o}C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ^{O}C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Reliability Test

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solder ability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5±0.5cm/s Tinning: A: 215°C/ 3±1s or B: 260°C/ 10±1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) T_{amb}25°C; I_F=20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	T_{amb}: 85°C Humidity: 85% R.H., I_F=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20/0	HT specs.	T_{amb}: 55°C I_F=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		T_{amb}25°C, I_f=20mA,, I_p=100mA, Duty cycle=0.125 (tp=125 μ s,T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min.. 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60±3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100±10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40±5°C for 500hrs